

X2-Class **Power MOSFET**

IXTP34N65X2 IXTH34N65X2

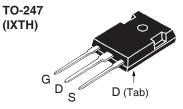
= 650V34A $96m\Omega$

N-Channel Enhancement Mode Avalanche Rated



Symbol	Test Conditions	Maximum Ra	Maximum Ratings		
V _{DSS}	T _J = 25°C to 150°C	650	V		
V _{DGR}	$T_{_{\mathrm{J}}}$ = 25°C to 150°C, $R_{_{\mathrm{GS}}}$ = 1M Ω	650	V		
V _{GSS}	Continuous	±30	V		
V _{GSM}	Transient	±40	V		
I _{D25}	T _C = 25°C	34	A		
I _{DM}	$T_{\rm C}^{\rm c}$ = 25°C, Pulse Width Limited by $T_{\rm JM}$	68	Α		
I _A	T _c = 25°C	17	A		
E _{AS}	T _C = 25°C	1	J		
dv/dt	$I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \leq 150^{\circ}\mathrm{C}$	15	V/ns		
$\overline{\mathbf{P}_{\scriptscriptstyle \mathrm{D}}}$	T _C = 25°C	540	W		
T _J		-55 +150	°C		
T_{JM}		150	°C		
T _{stg}		-55 +150	°C		
T,	Maximum Lead Temperature for Soldering	300	°C		
T _{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C		
M _d	Mounting Torque	1.13 / 10	Nm/lb.in		
Weight	TO-220 TO-247	3 6	g g		

TO-220 (IXTP)	GDS TO (Tab)
TO-247 (IXTH)	



G = Gate	D	= Drain
S = Source	Tab	= Drain

Features

- International Standard Packages
- Low $R_{DS(ON)}$ and Q_G Avalanche Rated
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

		teristic Values Typ. Max.			
BV _{DSS}	$V_{GS} = 0V, I_D = 1mA$	650			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250\mu A$	3.0		5.0	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{L} = 125^{\circ}C$			10 150	μ Α μ Α
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$			96	mΩ



Symbol	Test Conditions	Characteristic Values		
$(T_J = 25^{\circ}C)$	C, Unless Otherwise Specified) M	in.	Тур.	Max
g _{fs}	$V_{DS} = 10V, I_{D} = 0.5 \bullet I_{D25}, Note 1$ 20)	33	S
R _{Gi}	Gate Input Resistance		0.90	Ω
C _{iss}	<u> </u>		3000	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		2180	pF
C _{rss}	J		1.7	pF
	Effective Output Capacitance			
$C_{o(er)}$	Energy related $\int V_{GS} = 0V$		125	pF
$C_{o(tr)}$	Time related $\int V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		490	pF
t _{d(on)}	Resistive Switching Times		30	ns
t _r	$\begin{cases} V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25} \end{cases}$		48	ns
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 10\Omega$ (External)		68	ns
t _f	$n_{\rm G} = 1052$ (External)		30	ns
Q _{g(on)})		54	nC
\mathbf{Q}_{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		15	nC
\mathbf{Q}_{gd}	J		20	nC
R _{thJC}				0.23 °C/W
\mathbf{R}_{thCS}	TO-220		0.50	°C/W
	TO-247		0.21	°C/W

Source-Drain Diode

Symbol	Test Conditions	Characteristic Values			
$(T_J = 25^{\circ}C)$, Unless Otherwise Specified)	Min.	Тур.	Max	
I _s	$V_{GS} = 0V$			34	Α
SM	Repetitive, pulse Width Limited by $T_{_{JM}}$			136	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.4	V
t _{rr} Q _{RM} J	$I_F = 17A$, -di/dt = 100A/ μ s $V_R = 100V$		390 4.2 21.8		ns µC A

Note 1. Pulse test, $t \le 300 \mu s$, duty cycle, $d \le 2\%$.



Fig. 1. Output Characteristics @ T_J = 25°C

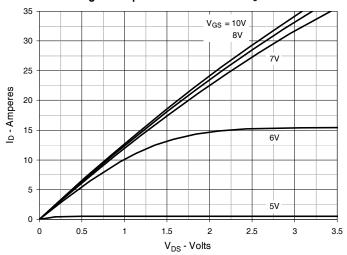


Fig. 2. Extended Output Characteristics @ T_J = 25°C

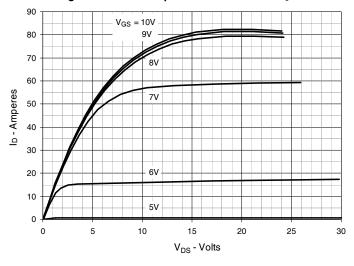


Fig. 3. Output Characteristics @ T_J = 125°C

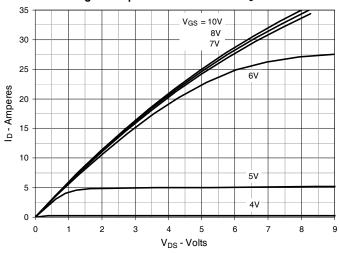


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 17A Value vs. Junction Temperature

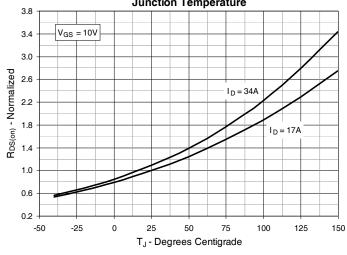


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 17A Value vs.

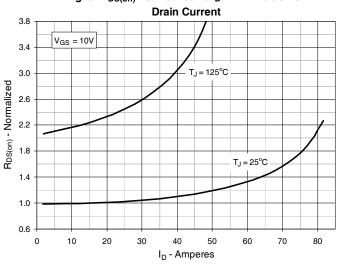
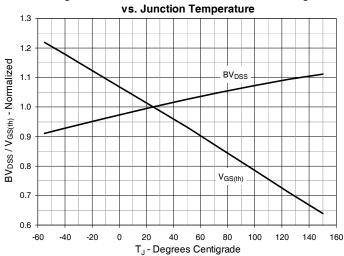
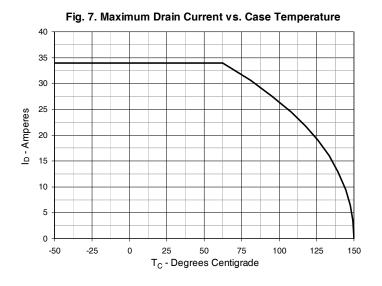
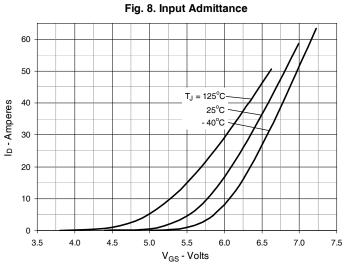


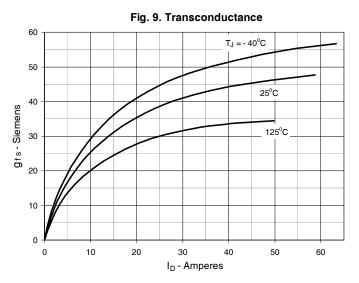
Fig. 6. Normalized Breakdown & Threshold Voltages

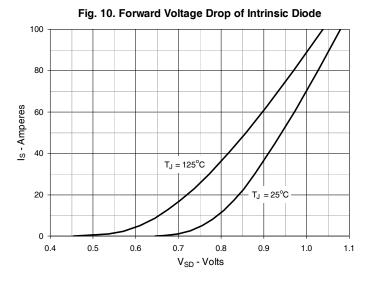


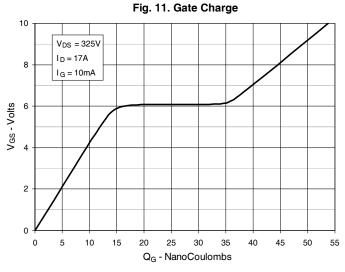


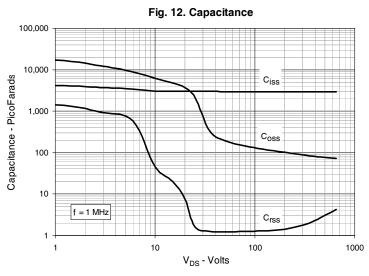






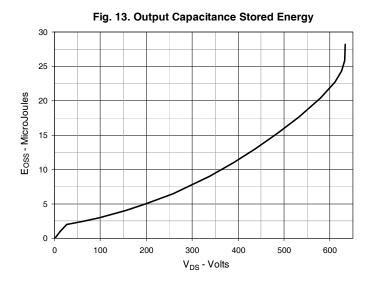






IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.





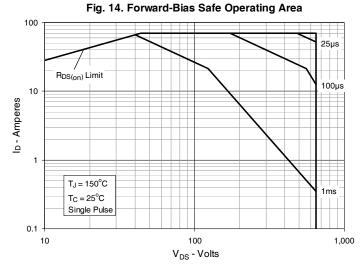


Fig. 15. Maximum Transient Thermal Impedance

